2N6497

High Voltage NPN Silicon Power Transistors

These devices are designed for high voltage inverters, switching regulators and line-operated amplifier applications. Especially well suited for switching power supply applications.

Features

- High Collector–Emitter Sustaining Voltage $V_{CEO(sus)} = 250 \text{ Vdc (Min)}$
- Excellent DC Current Gain -

 $h_{FE} = 10-75$ @ $I_C = 2.5$ Adc

- Low Collector–Emitter Saturation Voltage @ $I_C = 2.5 \text{ Adc} V_{CE(sat)} = 1.0 \text{ Vdc (Max)}$
- Pb-Free Packages are Available*



Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CEO}	250	Vdc
Collector-Base Voltage	V _{CB}	350	Vdc
Emitter-Base Voltage	V _{EB}	6.0	Vdc
Collector Current – Continuous – Peak	IC	5.0 10	Adc
Base Current	Ι _Β	2.0	Adc
Total Power Dissipation @ T _C = 25°C Derate above 25°C	P _D	80 0.64	W W/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +150	°C

THERMAL CHARACTERISTICS

Characteristics	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.56	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Indicates JEDEC Registered Data.

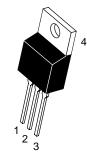


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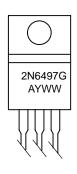
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5 AMPERE POWER TRANSISTORS NPN SILICON 250 VOLTS – 80 WATTS

MARKING DIAGRAM



TO-220AB CASE 221A STYLE 1



2N6497 = Device Code G = Pb-Free Package A = Assembly Location

Y = Year WW = Work Week

ORDERING INFORMATION

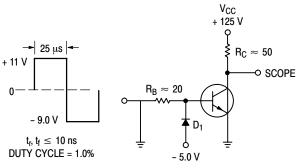
Device	Package	Shipping		
2N6497	TO-220AB	50 Units / Rail		
2N6497G	TO-220AB (Pb-Free)	50 Units / Rail		

^{*}For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted) (Note 2)

Characteristic	Symbol	Min	Тур	Max	Unit		
OFF CHARACTERISTICS							
Collector–Emitter Sustaining Voltage (Note 3) (I _C = 25 mAdc, I _B = 0)	V _{CEO(sus)}	250	_	_	Vdc		
Collector Cutoff Current $(V_{CE} = 350 \text{ Vdc}, V_{BE(off)} = 1.5 \text{ Vdc})$ $(V_{CE} = 175 \text{ Vdc}, V_{BE(off)} = 1.5 \text{ Vdc}, T_{C} = 100^{\circ}\text{C})$	ICEX	_ _	- -	1.0 10	mAdc		
Emitter Cutoff Current (V _{BE} = 6.0 Vdc, I _C = 0)	I _{EBO}	-	-	1.0	mAdc		
ON CHARACTERISTICS (Note 3)							
DC Current Gain ($I_C = 2.5 \text{ Adc}$, $V_{CE} = 10 \text{ Vdc}$) ($I_C = 5.0 \text{ Adc}$, $V_{CE} = 10 \text{ Vdc}$)	h _{FE}	10 3.0	_ _	75 -	-		
Collector–Emitter Saturation Voltage ($I_C = 2.5 \text{ Adc}$, $I_B = 500 \text{ mAdc}$) ($I_C = 5.0 \text{ Adc}$, $I_B = 2.0 \text{ Adc}$)	V _{CE(sat)}	_ _	_ _	1.0 5.0	Vdc		
Base–Emitter Saturation Voltage $(I_C = 2.5 \text{ Adc}, I_B = 500 \text{ mAdc})$ $(I_C = 5.0 \text{ Adc}, I_B = 2.0 \text{ Adc})$	V _{BE(sat)}	_ _	- -	1.5 2.5	Vdc		
DYNAMIC CHARACTERISTICS							
Current-Gain – Bandwidth Product (I _C = 250 mAdc, V _{CE} = 10 Vdc, f = 1.0 MHz)	f _T	5.0	_	_	MHz		
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 100 kHz)	C _{ob}	-	-	150	pF		
SWITCHING CHARACTERISTICS							
Rise Time (V_{CC} = 125 Vdc, I_{C} = 2.5 Adc, I_{B1} = 0.5 Adc)	t _r	-	0.4	1.0	μs		
Storage Time $(V_{CC} = 125 \text{ Vdc}, I_C = 2.5 \text{ Adc}, V_{BE} = 5.0 \text{ Vdc}, I_{B1} = I_{B2} = 0.5 \text{ Adc})$	t _S	_	1.4	2.5	μs		
Fall Time (V _{CC} = 125 Vdc, I _C = 2.5 Adc, I _{B1} = I _{B2} = 0.5 Adc)	t _f	_	0.45	1.0	μs		

- 2. Indicates JEDEC Registered Data.
- 3. Pulse Test: Pulse Width \leq 300 $\mu\text{s},$ Duty Cycle \leq 2.0%.



 ${\rm R}_{\rm B}$ and ${\rm R}_{\rm C}$ varied to obtain desired current levels

D₁ MUST BE FAST RECOVERY TYPE, e.g.: 1N5825 USED ABOVE I_B \approx 100 mA MSD6100 USED BELOW I_B \approx 100 mA

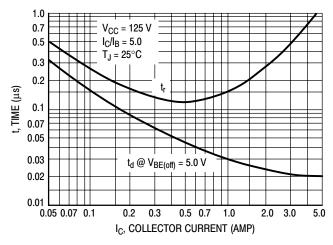
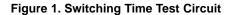


Figure 2. Turn-On Time



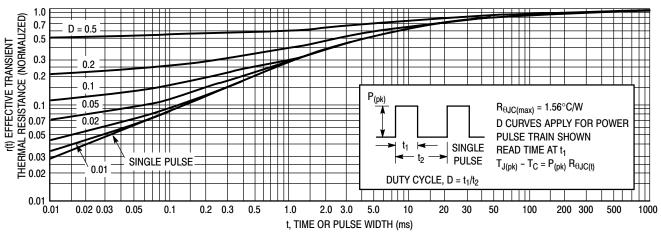


Figure 3. Thermal Response

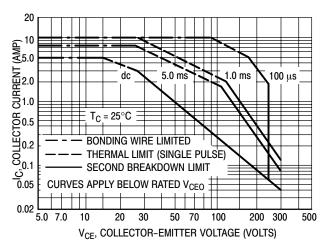


Figure 4. Active-Region Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 4 is based on $T_C = 25^{\circ}C$; $T_{J(pk)}$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \leq 150^{\circ}C$. $T_{J(pk)}$ may be calculated from the data in Figure 3. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown. Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltage shown on Figure 4 may be found at any case temperature by using the appropriate curve on Figure 6.

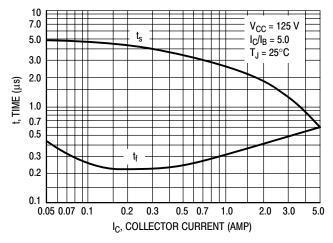


Figure 5. Turn-Off Time

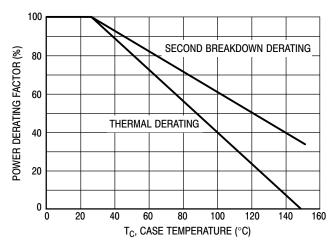
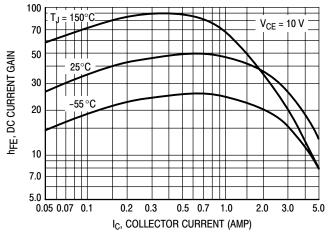


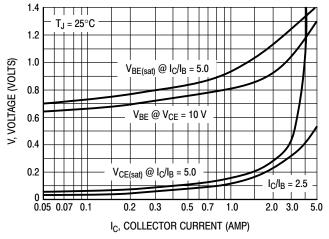
Figure 6. Power Derating



V_{CE}, COLLECTOR-EMITTER VOLTAGE (VOLTS 4.0 T_J = 25°C 3.2 2.4 1.6 $I_{C} = 1.0 A$ 3.0 A 2.0 A 5.0 A 8.0 0.01 0.02 0.05 2.0 5.0 10 0.1 0.5 IB, BASE CURRENT (mA)

Figure 7. DC Current Gain

Figure 8. Collector Saturation Region



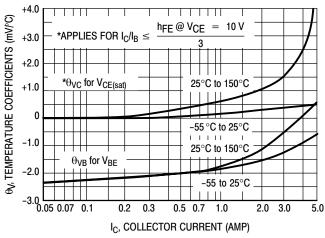
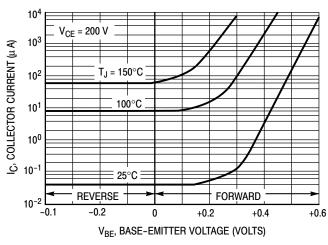


Figure 9. "On" Voltages

Figure 10. Temperature Coefficients



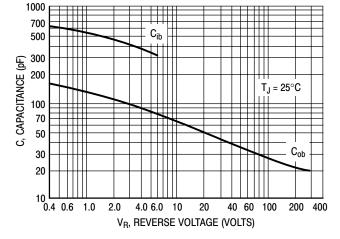


Figure 11. Collector Cutoff Region

Figure 12. Capacitance

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